Amendments to the Specification:

Page 2, please add the following section between lines 11 and 13:

BRIEF DESCRIPTION OF THE DRAWING

Figure 1 is a side view of a heat-generating device, film and cold sink.

Page 2, please replace the paragraph starting on line 24 and continuing through line 3 of page 3 with the following replacement paragraph:

The thermal interface material of the present invention may be utilized with virtually any heat-generating component for which it is desired to dissipate the heat. In particular, the thermal interface material is useful for aiding in the dissipation of heat from heat-generating components in semiconductor devices. In such devices, <u>as shown in Figure 1</u>, the thermal interface material <u>1</u> forms a layer between the heat-generating component <u>2</u> and the cold sink <u>3</u> and transfers the heat to be dissipated to the cold sink.